

December 14-17 2025

International Conference on Microelectronics (Hybrid)



IEEE Lebanon Joint Chapter



IE13/ PE31/ CAS04/ PEL3 Lebanon Chapter

Honorary co-Chair:

Mohamed Elmasry, Waterloo Univ., Canada

Conference co-Chairs:

Mohamad Sawan, Westlake Univ., China

Yehea Ismail, AUC, Egypt

Technical Program co-Chairs:

Ahmed Madian, IEEE CAS, Egypt

Adnan Harb, LIU, Lebanon

Abdallah Kassem, NDU, Lebanon

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Mohamed Abid, Tunisia

Special Session co-Chairs:

Tales Pimenta, UFI, Brazil

Vassilis Alimisis, NTUA, Greece

Ahmad Kobeissi, LIU, Lebanon

Majd Saied, LIU, Lebanon

Industrial Relation Chairs:

Rabih Rammal, LIU, Lebanon

Ali M. Haidar, BAU, Lebanon

Xiaojin Zhao, Shenzhen University, China

Local Arrangement co-Chairs:

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Ahmed Madian, IEEE CAS, Egypt

Tutorials co-Chairs

Mourad Loulou, NES, Tunisia

Hani Saleh, KU, UAE

Ali M. Haidar, BAU, Lebanon

Ahmad Diab, LIU, Lebanon

International Coordinators

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Maitham Shams, Carleton University, Canada

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Mohammed Ismail, W.S.U, USA

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Nabil Karami, UCT, UAE

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Raafat Lababidi, Ensta, France

Said Elnaffar, CUD, UAE

Tales Pimenta, UFI, Brazil

The International Conference on Microelectronics has already been held numerous times in different countries across the Middle East, Southern Europe, and Asia for the past 36 years. The 37th edition of the conference will take place hybrid in Cairo, Egypt. ICM 2025 will include oral, poster sessions and tutorials given by experts on state-of-the-art topics. The regular technical program will run for three days. In addition, tutorial sessions will be held on the first day of the conference. ICM 2025 is a highly technical conference that focuses on the latest developments in circuits and systems research. As such, the conference is primarily aimed at researchers, academics, engineers, and professionals in the field of circuits and systems. The conference, spanning over four days, will include peer-reviewed paper submissions, and accepted papers will be considered for inclusion in IEEE Xplore.

Papers are solicited in, but not limited to, the following topics:

- ☐ Circuits and Systems
- ☐ Digital signal and data processing
- ☐ AI
- ☐ IoT and Wireless communication systems
- ☐ Analog and RF circuit design techniques
- ☐ Nonlinear circuits
- ☐ VLSI for signal and image processing
- ☐ System on chip (SoCs)
- ☐ Integrated antenna and front-end co-design
- ☐ IoT circuits and security
- ☐ Metaverse and Sensors
- ☐ Biomedical circuits and systems
- ☐ CAD Tools and Design
- ☐ Simulation (process, device, circuit, logic, timing, function)
- ☐ Silicon optimization
- ☐ Parallel embedded systems
- ☐ Testing: Formal verification
- ☐ CAD for FPGAs
- ☐ High-level synthesis tools
- ☐ Design for testability
- ☐ Micro/Nanoelectronics
- ☐ Device characterization and modelling
- ☐ Device physics and novel structures
- ☐ Process technology, CMOS, BJT, BiCMOS, GaAs
- ☐ Reliability and failure analysis
- ☐ Optoelectronics
- ☐ MEMS devices
- ☐ Packaging and surface mount technology

Paper Submission

Authors are invited to submit papers in PDF using according to IEEE formatting guidelines. Paper template could be downloaded from the following website:

https://www.ieee.org/conferences_events/conferences/publishing/templates.html

Electronic submission of papers should be done via EDAS:

<https://edas.info/newPaper.php?c=33298>

Questions regarding submission should be directed to info@ieee-icm.org

Accepted and presented papers for authors who complete registration will be submitted for inclusion to IEEE Xplore.

Review Process

The evaluation of submitted papers is based on the importance and usefulness of the research topic. Technical merits, novelty of the approach, soundness of results, and clarity of presentation are also considered as factors of the evaluation process. Each paper will be fully reviewed by a minimum of Three specialized reviewers.

Important Dates:

Full Paper Submission

: October 15th, 2025

Paper's Notification

: November 15th, 2025

Camera Ready

: November 30th, 2025

Submission of Special Sessions Proposals

: September 25th, 2025

Submission of Tutorials Proposals

: September 25th, 2025

Notification of Tutorials Proposals Acceptance

: September 30th, 2025

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: September 30th, 2025